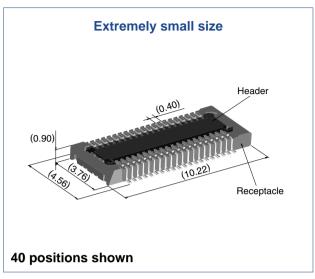
# 0.4 mm Pitch, 0.9 mm Height, Board-to-Board / Board-to-FPC Connectors

### **DF30 Series**





#### Overview

Continuous miniaturization and increased component density on PCB created demand for extremely low profile connectors. This series is addition of a new extremely low profile connectors to Hirose's wide range of high reliability board-to-board/board-to-FPC connection solutions.

#### Features

### 1. Contact reliability

Concentration of the contact's normal forces at the single point assures good contact wipe and electrical reliability, while confirming the fully mated condition with a definite tactile click.

#### 2. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces the connectors will self align in horizontal axis within 0.3 mm.

#### 3. Automatic board placement

Packaged on tape-and-reel the plug and headers have sufficiently large flat areas to allow pick-up with vacuum nozzles of automatic placement equipment.

#### 4. Variety of contact positions and styles

Available in standard contact positions of: 20, 22, 24, 30, 34, 40, 50, 60, 70 and 80 with and without metal fittings. Addition of metal fittings does not affect external dimensionsof the connectors.

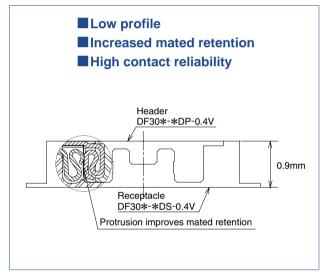
Smaller contact positions are also available.

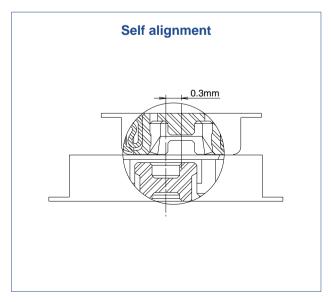
#### 5. Support for continuity test connector

Connectors which have increased insertion and removal durability are available for continuity tests. Contact your Hirose sales representative for details.

### Applications

Cellular phones, PDA's, mobile computers, digital cameras, digital video cameras, and other devices demanding high reliability connections in extremely limited spaces.





## **■**Product Specifications

	Datina	Rated current 0.3A	Operating temperature range	: -35°C to 85°C (Note 1)	Storage temperature range	-10°C to 60°C (Note 2)
Rating	Rated voltage 30V AC	Operating humidity range	: Relative humidity 20% to 80%	Storage humidity range	Relative humidity 40% to 70% (Note 2)	

Item	Specification	Conditions
1. Insulation resistance	50 MΩ min.	100V DC
2. Withstanding voltage	No flashover or insulation breakdown.	100V AC / one minute
3. Contact resistance	100 mΩ max.	100 mA
4. Vibration	No electrical discontinuity of 1 $\mu$ s or more	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours, 3 axis
5. Humidity	Contact resistance: 100 m $\Omega$ max. Insulation resistance: 25 M $\Omega$ min.	96 hours at temperature of 40°C±2°C and RH of 90% to 95%
6. Temperature cycle	Contact resistance: 100 m $\Omega$ max. Insulation resistance: 50 M $\Omega$ min.	Temperature: $-55^{\circ}C \rightarrow +5^{\circ}C$ to $+35^{\circ}C \rightarrow +85^{\circ}C \rightarrow +5^{\circ}C$ to $+35^{\circ}C$ Duration: $30 \rightarrow 10 \rightarrow 30 \rightarrow 10$ (Minutes) 5 cycles
7. Durability (insertions/withdrawals)	Contact resistance: 100 mΩ max.	50 cycles(Connector for conductivity tests: 500 cycles)
8. Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 300°C for 3 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

## **■**Materials and Finishes

Connectors	Component	Material	Finish	Remarks
Receptacles	Insulator	LCP	Color : Black	UL94V-0
and	Contacts	Phosphor bronze	Gold plated	
Headers	Metal fittings	Phosphor bronze	Tin-cupper plated	

## **■**Ordering information

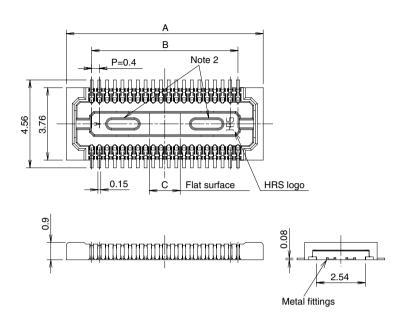
## Receptacles and Headers

DF30	FC -	*	DS -	0.4	V	(**)
<u> </u>	2	6	4	6	6	7

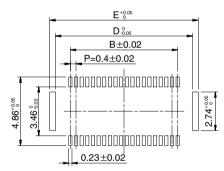
1 Series name: DF30	6 Contact pitch: 0.4 mm
2 Configuration	6 Termination section
FB: With metal fittings, without bosses	V: Straight SMT
FC: Without metal fittings, without bosses	Packaging
CJ: Connector for conductivity tests	(81): Embossed tape packaging (5,000 pieces per reel)
3 Number of positions: 20, 22, 24, 30, 34, 40, 50, 60, 70, 80	(82): Embossed tape packaging (1,000 pieces per reel)
4 Connector type	
DS: Double row receptacle	
DP: Double row header	

## **■**Receptacles (with metal fittings)





# **●**Recommended PCB mounting pattern



Recommended solder paste thickness: 120  $\mu m$ 

[Specification number] -\*\*\*, (\*\*)

(81): Embossed tape packaging (5,000 pieces per reel)

\* Tolerances non- accumulative.

Unit: mm

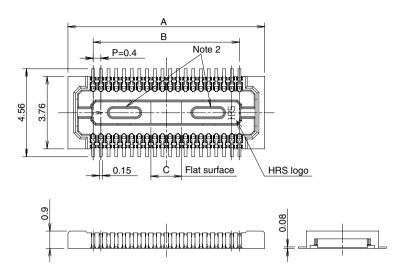
Part Number	CL No.	Number of contacts	А	В	С	D	Е
DF30FB-20DS-0.4V(**)	CL684-1098-3-**	20	6.22	3.6	1.2	5.72	6.52
DF30FB-22DS-0.4V(**)	CL684-1099-6-**	22	6.62	4.0	1.2	6.12	6.92
DF30FB-24DS-0.4V(**)	CL684-1100-3-**	24	7.02	4.4	1.2	6.52	7.32
DF30FB-30DS-0.4V(**)	CL684-1101-6-**	30	8.22	5.6	1.2	7.72	8.52
DF30FB-34DS-0.4V(**)	CL684-1102-9-**	34	9.02	6.4	1.36	8.52	9.32
DF30FB-40DS-0.4V(**)	CL684-1103-1-**	40	10.22	7.6	1.6	9.72	10.52
DF30FB-50DS-0.4V(**)	CL684-1104-4-**	50	12.22	9.6	2.0	11.72	12.52
DF30FB-60DS-0.4V(**)	CL684-1105-7-**	60	14.22	11.6	2.4	13.72	14.52
DF30FB-70DS-0.4V(**)	CL684-1106-0-**	70	16.22	13.6	2.8	15.72	16.52
DF30FB-80DS-0.4V(**)	CL684-1107-2-**	80	18.22	15.6	3.2	17.72	18.52

Note 1: Order by number of reels.

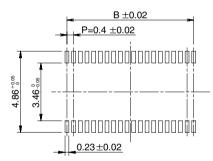
Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

## ■Receptacles (without metal fittings)





# 



Recommended solder paste thickness: 120  $\mu m$ 

[Specification number] -\*\*, (\*\*)
(81): Embossed tape packaging (5,000 pieces per reel)

\* Tolerances non- accumulative.

Unit: mm

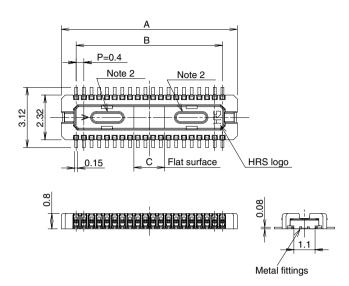
Part Number	CL No.	Number of contacts	А	В	С
DF30FC-20DS-0.4V(**)	CL684-1109-8-**	20	6.22	3.6	1.2
DF30FC-22DS-0.4V(**)	CL684-1110-7-**	22	6.62	4.0	1.2
DF30FC-24DS-0.4V(**)	CL684-1111-0-**	24	7.02	4.4	1.2
DF30FC-30DS-0.4V(**)	CL684-1112-2-**	30	8.22	5.6	1.2
DF30FC-34DS-0.4V(**)	CL684-1113-5-**	34	9.02	6.4	1.36
DF30FC-40DS-0.4V(**)	CL684-1078-6-**	40	10.22	7.6	1.6
DF30FC-50DS-0.4V(**)	CL684-1114-8-**	50	12.22	9.6	2.0
DF30FC-60DS-0.4V(**)	CL684-1082-3-**	60	14.22	11.6	2.4
DF30FC-70DS-0.4V(**)	CL684-1115-0-**	70	16.22	13.6	2.8
DF30FC-80DS-0.4V(**)	CL684-1116-3-**	80	18.22	15.6	3.2

Note 1: Order by number of reels.

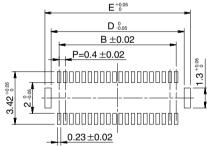
Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

## ■Header (with metal fittings)





# **●**Recommended PCB mounting pattern



Recommended solder paste thickness: 120  $\mu m$ 

[Specification number] -\*\*\*, (\*\*)

(81): Embossed tape packaging (5,000 pieces per reel)

\* Tolerances non- accumulative.

Unit: mm

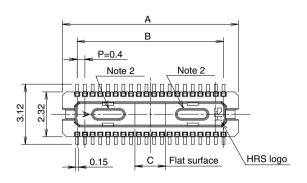
Part Number	CL No.	Number of contacts	А	В	С	D	E
DF30FB-20DP-0.4V(**)	CL684-1129-5-**	20	5.14	3.6	1.2	4.64	5.44
DF30FB-22DP-0.4V(**)	CL684-1130-4-**	22	5.54	4.0	1.2	5.04	5.84
DF30FB-24DP-0.4V(**)	CL684-1131-7-**	24	5.94	4.4	1.2	5.44	6.24
DF30FB-30DP-0.4V(**)	CL684-1132-0-**	30	7.14	5.6	1.2	6.64	7.44
DF30FB-34DP-0.4V(**)	CL684-1133-2-**	34	7.94	6.4	1.36	7.44	8.24
DF30FB-40DP-0.4V(**)	CL684-1134-5-**	40	9.14	7.6	1.6	8.64	9.44
DF30FB-50DP-0.4V(**)	CL684-1135-8-**	50	11.14	9.6	2.0	10.64	11.44
DF30FB-60DP-0.4V(**)	CL684-1074-5-**	60	13.14	11.6	2.4	12.64	13.44
DF30FB-70DP-0.4V(**)	CL684-1075-8-**	70	15.14	13.6	2.8	14.64	15.44
DF30FB-80DP-0.4V(**)	CL684-1136-0-**	80	17.14	15.6	3.2	16.64	17.44

Note 1: Order by number of reels.

Note 2: Headers with 24 or fewer contacts positions will not have protruding areas.

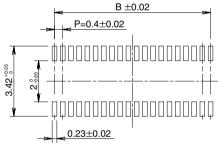
## ■Header (without metal fittings)







## **●**Recommended PCB mounting pattern



Recommended solder paste thickness: 120  $\mu$ m

[Specification number] -\*\*\*, (\*\*)

(81): Embossed tape packaging (5,000 pieces per reel)

\* Tolerances non- accumulative.

Unit: mm

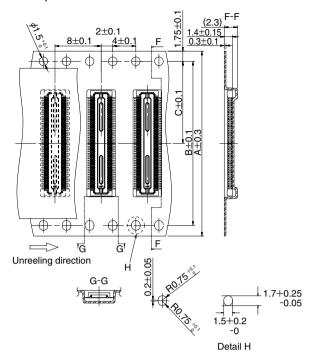
Part Number	CL No.	Number of contacts	Α	В	С		
DF30FC-20DP-0.4V(**)	CL684-1138-6-**	20	5.14	3.6	1.2		
DF30FC-22DP-0.4V(**)	CL684-1139-9-**	22	5.54	4.0	1.2		
DF30FC-24DP-0.4V(**)	CL684-1140-8-**	24	5.94	4.4	1.2		
DF30FC-30DP-0.4V(**)	CL684-1141-0-**	30	7.14	5.6	1.2		
DF30FC-34DP-0.4V(**)	CL684-1142-3-**	34	7.94	6.4	1.36		
DF30FC-40DP-0.4V(**)	CL684-1079-9-**	40	9.14	7.6	1.6		
DF30FC-50DP-0.4V(**)	CL684-1143-6-**	50	11.14	9.6	2.0		
DF30FC-60DP-0.4V(**)	CL684-1083-6-**	60	13.14	11.6	2.4		
DF30FC-70DP-0.4V(**)	CL684-1077-3-**	70	15.14	13.6	2.8		
DF30FC-80DP-0.4V(**)	CL684-1144-9-**	80	17.14	15.6	3.2		

Note 1: Order by number of reels.

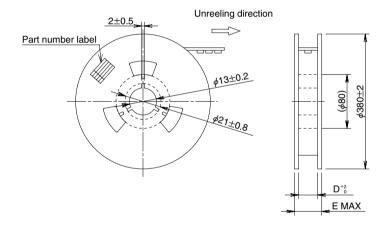
Note 2: Headers with 24 or fewer contacts positions will not have protruding areas.

# **●** Packaging Specification

### • Embossed Carrier Tape Dimensions - Receptacle



#### Reel Dimensions

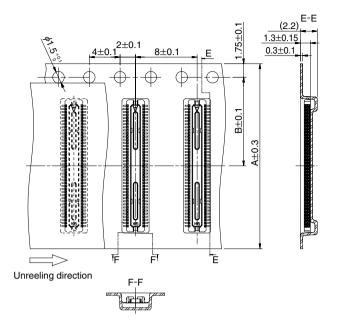


Unit: mm

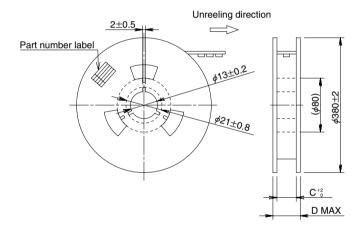
Part Number	А	В	С	D	Е
DF30#-20DS-0.4V(**)	16.0	_	7.5	16.4	22.4
DF30#-22DS-0.4V(**)	16.0	_	7.5	16.4	22.4
DF30#-24DS-0.4V(**)	16.0	_	7.5	16.4	22.4
DF30#-30DS-0.4V(**)	16.0	-	7.5	16.4	22.4
DF30#-34DS-0.4V(**)	16.0	-	7.5	16.4	22.4
DF30#-40DS-0.4V(**)	24.0	_	11.5	24.4	30.4
DF30#-50DS-0.4V(**)	24.0	_	11.5	24.4	30.4
DF30#-60DS-0.4V(**)	24.0	_	11.5	24.4	30.4
DF30#-70DS-0.4V(**)	24.0	_	11.5	24.4	30.4
DF30#-80DS-0.4V(**)	32.0	28.4	14.2	32.4	38.4

Embossed tape 32mm or wider will have perforated feed holes on two sides.

### • Embossed Carrier Tape Dimensions - Header



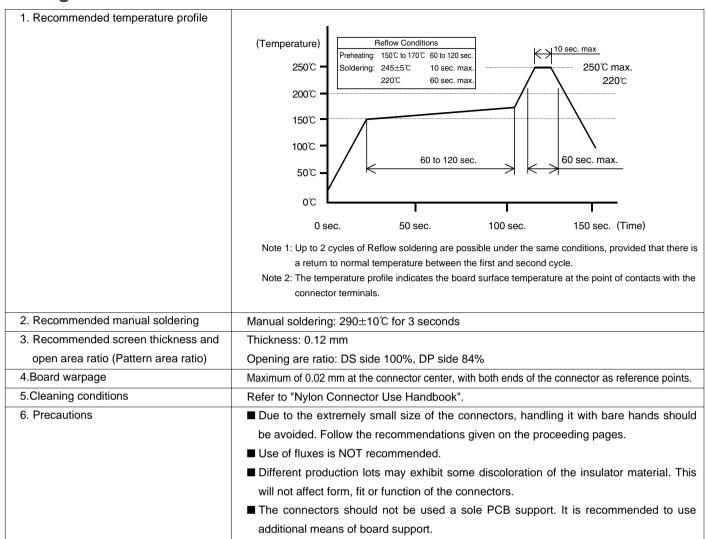
### Reel Dimensions



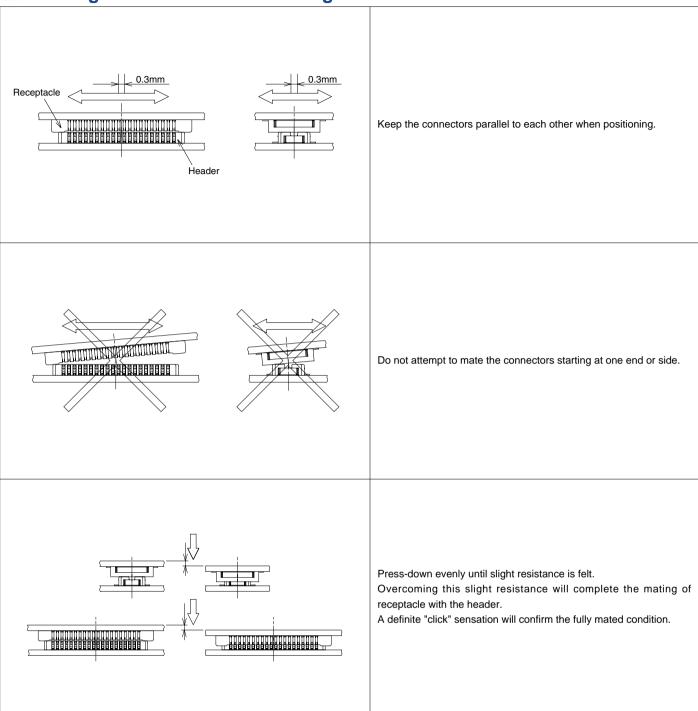
Unit: mm

Part Number	Α	В	С	D
DF30#-20DP-0.4V(**)	16.0	7.5	16.4	22.4
DF30#-22DP-0.4V(**)	16.0	7.5	16.4	22.4
DF30#-24DP-0.4V(**)	16.0	7.5	16.4	22.4
DF30#-30DP-0.4V(**)	16.0	7.5	16.4	22.4
DF30#-34DP-0.4V(**)	16.0	7.5	16.4	22.4
DF30#-40DP-0.4V(**)	16.0	7.5	16.4	22.4
DF30#-50DP-0.4V(**)	24.0	11.5	24.4	30.4
DF30#-60DP-0.4V(**)	24.0	11.5	24.4	30.4
DF30#-70DP-0.4V(**)	24.0	11.5	24.4	30.4
DF30#-80DP-0.4V(**)	24.0	11.5	24.4	30.4

### Usage Recommendations



# **●** Handling Precautions when mating the connectors



## **●** Handling Precautions when un-mating the connectors

